

Overview

HP EliteBook x360 1040 G8 Notebook PC



Left

- | | |
|-------------------------|---|
| 1. Internal Microphones | 6. Nano Security lock slot (Lock sold separately) |
| 2. IR Camera LEDs | 7. WWAN SIM (Nano) |
| 3. Webcam and IR Camera | 8. Audio Combo Jack |
| 4. Webcam LED | 9. SuperSpeed USB Type-A 5Gbps signaling rate (Charging port) (USB 3.2 Gen 1) |
| 5. Glass Clickpad | |

Overview



Right

1. Power button
2. SuperSpeed USB Type-A 5Gbps signaling rate (Charging port) (USB 3.2 Gen 1)
3. HDMI 2.0 port (Cable not included)
4. Thunderbolt™ 4 with USB4™ Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4)¹
5. Thunderbolt™ 4 with USB4™ Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4)¹
6. Battery LED

1. SuperSpeed USB 20Gbps is not available with Thunderbolt™ 4.

Overview

AT A GLANCE

- Windows 11 Pro, other Windows OS or FreeDOS preinstalled
 - An all metal CNC Aluminum chassis that is .6 inches (1.66 cm) thin (at front) and with a starting weight of 2.9 lbs. (1.31 Kg)
 - A 360° convertible notebook with 4 usage modes: Laptop mode, Tablet mode, Tent mode, and Media mode
 - Choice of 11th Generation Intel® Core™ i5, i7 Processors with integrated Intel® Iris® Xe Graphics supporting dual channel LP DDR4X memory up to 32 GB and solid state storage up to 2 TB
 - Intel® EVO configurations available
 - Touch display choices include 35.56 cm (14.0") diagonal IPS FHD displays and stunning UHD HDR-400 display. Optional Anti-glare screen available on FHD panels. Get added protection in open or public places with the optional HP Sure View Reflect integrated privacy screen
 - Ultimate connectivity with dual Thunderbolt™ 4² with USB4 support ports, dual USB 3.1 Gen1 charging ports, and HDMI 2.0. Stay connected where you need to with additional choices of 5G or 4G/LTE WWAN, WLAN and optional Thunderbolt™ Docking (Sold separately)
 - Featuring HP Quiet Keyboard with the HP Programmable key. The power button, HP Sure Shutter and the fingerprint sensor are also located on the keyboard
 - An optional HP Rechargeable Active Pen 31 with Magnetic Attach and 4096 Levels of pressure
 - Never forget your password with your choice of simple authentication methods, including the IR camera for face recognition and Touch Fingerprint Sensor for Windows Hello
 - Enterprise grade security with HP Sure Sense, HP Sure Start, HP Sure Shutter, HP Sure View Reflect (optional), HP Sure Run, HP Sure Recover with Embedded Reimaging, HP Sure Click, HP Tamper Lock and Touch Fingerprint sensor
 - HP Sure Shutter - industry's 1st camera with an electric shutter. The on/off button for this shutter is located on the function row of the keyboard.
 - Two choices for the system battery: a 54.5 Wh battery for lighter configurations and a 78.5 Wh battery for the longest battery life. Battery Life up to 14 hours 45 minutes (54 Wh battery) (MobileMark2018) and up to 22 hours (78 Wh battery) (MobileMark2018).
 - AI based HP Context Aware to maximize performance when working at a table, comfort when working from your lap, and responsiveness when working on the go.
 - Auto Lock and Awake (prev. Presence Aware) automatically locks your system when you leave and seamlessly authenticates with Window's Hello
 - HP Dynamic Audio, a new AI-based audio experience, tunes output to speech, music, and movies all while suppressing background noise. (Planned to be available March 2021)
 - HP Sound Calibration to uniquely tune end user headphone audio. (Planned to be available March 2021)
 - Passed 19 MIL-STD 810H tests¹
1. MIL-STD 810H is not intended to demonstrate fitness of U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.
 2. SuperSpeed USB 20Gbps is not available with Thunderbolt™ 4.

NOTE: See important legal disclosures for all listed specs in their respective features sections.

Technical Specifications

PRODUCT NAME

HP EliteBook x360 1040 G8 Notebook PC

OPERATING SYSTEM

Preinstalled

Windows 11 Pro ²
Windows 11 Pro Education ²
Windows 11 Home – HP recommends Windows 11 Pro for business ²
Windows 11 Home Single Language – HP recommends Windows 11 Pro for business ²
Windows 11 Pro (Windows 11 Enterprise available with a Volume Licensing Agreement) ²
Windows 10 Pro ^{1,2}
Windows 10 Pro Education^{1,2}
Windows 10 Home – HP recommends Windows 11 Pro for business ^{1,2}
Windows 10 Home Single Language – HP recommends Windows 11 Pro for business ^{1,2}
Windows 10 Pro (Windows 10 Enterprise available with a Volume Licensing Agreement) ^{1,2}
FreeDOS

1. Device comes with Windows 10 and a free Windows 11 upgrade or may be preloaded with Windows 11. Upgrade timing may vary by device. Features and app availability may vary by region. Certain features require specific hardware (see Windows 11 Specifications).

2. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>.

PROCESSORS

Intel® Core™ i7-1185G7 (3.0 GHz base frequency, up to 4.8 GHz frequency with Intel® Turbo Boost Technology, 12 MB L3 cache, 4 cores) supports Intel® vPro® Technology ^{3,4,5,6}

Intel® Core™ i7-1165G7 ((2.8 GHz base frequency, up to 4.7 GHz with Intel® Turbo Boost Technology, 12 MB L3 cache, 4 cores) ^{3,4,5,6}

Intel® Core™ i5-1145G7 (2.6 GHz base frequency, up to 4.4 GHz frequency with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores) supports Intel® vPro® Technology ^{3,4,5,6}

Intel® Core™ i5-1135G7 (2.4 GHz base frequency, up to 4.2 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores) ^{3,4,5,6}

Processor Family

11th Generation Intel® Core™ i7 processor (i7-1185G7 and 1165G7) ⁶

11th Generation Intel® Core™ i5 processor (i5-1145G7 and 1135G7) ⁶

3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See <http://www.intel.com/technology/turboboost> for more information.

6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on <http://www.support.hp.com>.

Technical Specifications

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

Intel® Iris® X^e Graphics

Supports

Support HD decode DX12 HDMI 2.0 ⁷

7. HDMI cable sold separately.

DISPLAY

Touch

35.6 cm (14") diagonal FHD IPS Ultraslim 2.0mm eDP + PSR2 BrightView touch screen with 0.4mm Gorilla® Glass 5, 400 nits, 72% NTSC (1920 x 1080) ^{9,10,11}

35.6 cm (14") diagonal FHD IPS Ultraslim 2.0mm eDP + PSR2 Anti-Glare touch screen with 0.4mm Gorilla® Glass 5, 400 nits, 72% NTSC (1920 x 1080) ^{9,10,11}

35.6 cm (14") diagonal UHD HDR400 IPS Ultraslim 2.0mm eDP + PSR BrightView touch screen with 0.4mm Gorilla® Glass 5, 550 nits, 72% NTSC (3840 x 2160) ^{9,10,11}

HP Sure View Reflect Integrated Privacy Screen 35.6 cm (14") diagonal FHD IPS Ultraslim 2.0mm eDP + PSR BrightView touch screen with 0.4mm Gorilla® Glass 5, 1000 nits, 72% NTSC (1920 x 1080) ^{9,10,11,12}

HP Sure View Reflect Integrated Privacy Screen 35.6 cm (14") diagonal FHD IPS Ultraslim 2.0mm eDP + PSR Anti-Glare touch screen with 0.4mm Gorilla® Glass 5, 1000 nits, 72% NTSC (1920 x 1080) ^{9,10,11,12}

HDMI 2.0⁸

Supports resolutions up to 4K@60Hz

8. HDMI cable sold separately.

9. FHD/HD content required to view FHD/HD images.

10. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

11. Actual brightness will be lower with touchscreen or Sure View.

12. HP Sure View integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

Technical Specifications

STORAGE AND DRIVES

Primary M.2 Storage

128 GB PCIe® Gen3x2 NVMe™ M.2 SSD TLC¹³

256 GB PCIe® Gen3x4 NVMe™ M.2 SSD TLC¹³

512 GB PCIe® Gen3x4 NVMe™ M.2 SSD TLC¹³

1 TB PCIe® Gen3x4 NVMe™ M.2 SSD TLC¹³

2 TB PCIe® Gen3x4 NVMe™ M.2 SSD TLC¹³

256 GB PCIe® NVMe™ Value M.2 SSD¹³

512 GB PCIe® NVMe™ Value M.2 SSD¹³

256 GB PCIe® Gen3x4 NVMe™ M.2 SED SS TLC OPAL 2¹³

512 GB PCIe® Gen 3x4 NVMe™ M.2 SED TLC OPAL2¹³

512 Intel® PCIe® NVMe™ QLC M.2 SSD with 32 GB Intel® Optane™ memory H10^{13,14}

13. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software

14. Intel® Optane™ H10 memory system acceleration does not replace or increase the DRAM in your system. Requires 8th Gen or higher Intel® Core™ processor, BIOS version with Intel® Optane™ supported, Windows 10 64-bit, and an Intel® Rapid Storage Technology (Intel® RST) driver.

MEMORY

Maximum Memory

32 GB LPDDR4X-4266 SDRAM

Memory

32 GB LPDDR4X-4266 SDRAM¹⁵

16 GB LPDDR4X-4266 SDRAM¹⁵

8 GB LPDDR4X-4266 SDRAM¹⁵

Memory Slots

Memory soldered down

LPDDR4X, System runs at: 4266

Supports Dual Channel Memory

15. All slots are non-accessible / non-upgradeable.

Technical Specifications

NETWORKING/COMMUNICATIONS

WLAN

Intel® Dual Band Wireless-AX201 802.11a/b/g/n/ac/ax (2x2) Wi-Fi® 6 and Bluetooth® 5 Combo, vPro® ¹⁶
Intel® Dual Band Wireless-AX201 802.11a/b/g/n/ac/ax (2x2) Wi-Fi® 6 and Bluetooth® 5 Combo, non-vPro® ¹⁶

WWAN

Intel® XMM™ 7360 LTE-Advanced Cat 9 ¹⁸
Qualcomm® Snapdragon™ X55 5G Modem (5G + LTE CAT 20)¹⁹

NFC

NPC300 Near Field Communication Module ²⁰

Miracast

Native Miracast Support ²¹

16. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs.

18. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. LTE not available on all products, in all regions.

19. 5G module is an optional feature that must be configured at purchase. AT&T and T-Mobile networks supported in the U.S. Module designed for 5G networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP, requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. 5G not available on all products, in all regions. Backwards compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select countries, where carrier supported.

20. Sold separately or as an optional feature.

21. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

AUDIO/MULTIMEDIA

Audio

Audio by Bang & Olufsen
4 Premium stereo speakers
Microphones (Multi Array including two user facing and two world-facing microphones)

Camera

Hybrid 720p HD camera with integrated electronic privacy shutter, HP Sure Shutter ²²
Note: The on/off button for this shutter is located on the function row of the keyboard.

Sensors

Accelerometer
Magnetometer
Gyroscope
Ambient light sensor
Hall sensor

22. HD content required to view HD images.

Technical Specifications

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Quiet Keyboard, spill resistant, Backlit keyboard and Durakeys

HP Quiet Keyboard, spill resistant, Backlit keyboard and Durakeys, privacy

Pointing Device

Glass ClickPad with multi-touch gesture support

Function Keys

F1 - Display Switching

F2 - Blank or Sure View

F3 - Brightness Down

F4 - Brightness up

F5 - Audio Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Keyboard Backlight

F10 - Insert

F11 - Airplane Mode

F12 - Programmable Key

Non-Function Keys

HP Sure Shutter

Power Key

Delete Key

Hidden Function Keys

Fn+R = Break

Fn+S = Sys Rq

Fn+C = Scroll Lock

Fn+E = Insert

Fn+W = Pause

Technical Specifications

SOFTWARE AND SECURITY

Preinstalled Software

BIOS

HP BIOSphere Gen6 ²³
HP Drive Lock & Automatic Drive Lock
BIOS Update via Network
HP Secure Erase ²⁴
Absolute Persistence Module ²⁵
HP LAN-Wireless Protection
USB enable/disable (via BIOS)

Software

HP Connection Optimizer ²⁶
HP Hotkey Support
myHP
HP Support Assistant ²⁷
HP QuickDrop ¹⁷
HP Noise Cancellation Software
Touchpoint Customizer for Commercial
HP Notifications
HP Privacy Settings
HP Wireless Button Driver
HP Power Manager
HP PC Hardware Diagnostics Windows
Buy Microsoft Office (sold separately)
Microsoft Defender ³¹
HP Smart Support ⁵³

Manageability Features

HP Driver Packs (download) ²⁸
HP Manageability Integration Kit Gen4 (download) ²⁹
HP Client Catalog (download)
HP Client Management Script Library (download)
HP Image Assistant (download)

Security Management

HP Client Security Manager Gen7 ³⁰
HP Fingerprint Sensor
HP Wolf Pro Security Edition³³
HP Sure Click ³⁴
HP Sure Sense³⁵
HP Sure Start Gen6 ³⁶
HP Sure Admin ³⁷
HP Sure Recover Gen4 ³⁸
HP Sure Run Gen4 ³⁹
TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified) ⁴⁰

17. HP Quick Drop requires Internet access and Windows 10 PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.

23. HP BIOSphere Gen6 is available on select HP Pro and Elite PCs. Features may vary depending on the platform and configurations.

24. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.

25. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is

Technical Specifications

limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit:

<https://www.absolute.com/about/legal/agreements/absolute/>

26. HP Connection Optimizer requires Windows 10.

27. HP Support Assistant requires Windows and Internet access.

28. HP Driver Packs not preinstalled, however available for download at <http://www.hp.com/go/clientmanagement>.

29. HP Manageability Integration Kit can be downloaded from

<http://www8.hp.com/us/en/ads/clientmanagement/overview.html>.

30. HP Client Security Manager Gen7 requires Windows and is available on the select HP Elite and Pro PCs.

31. Windows Defender Opt in and internet connection required for updates.

33. HP Wolf Pro Security Edition (including HP Sure Click Pro and HP Sure Sense Pro) is available preloaded on select SKUs and, depending on the HP product purchased, includes a paid 1-year or 3-year license. The HP Wolf Pro Security Edition software is licensed under the license terms of the HP Wolf Security Software - End-User license Agreement (EULA) that can be found at: https://support.hp.com/us-en/document/ish_3875769-3873014-16 as that EULA is modified by the following:

“7. Term. Unless otherwise terminated earlier pursuant to the terms contained in this EULA, the license for the HP Wolf Pro Security Edition (HP Sure Sense Pro and HP Sure Click Pro) is effective upon activation and will continue for either a twelve (12) month or thirty-six (36) month license term (“Initial Term”). At the end of the Initial Term you may either (a) purchase a renewal license for the HP Wolf Pro Security Edition from HP.com, HP Sales or an HP Channel Partner, or (b) continue using the standard versions of HP Sure Click and HP Sure Sense at no additional cost with no future software updates or HP Support.

34. HP Sure Click requires Windows 10 Pro or Enterprise. See https://bit.ly/2PrLT6A_SureClick for complete details.

35. HP Sure Sense is available on select HP PCs and is not available with Windows10 Home.

36. HP Sure Start Gen6 is available on select HP PCs.

37. HP Sure Admin requires Windows 10, HP BIOS, HP Manageability Integration Kit from

<http://www.hp.com/go/clientmanagement> and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.

38. HP Sure Recover Gen4 is available on select HP PCs and requires an open network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data.

39. HP Sure Run Gen4 is available on select Windows 10 based HP Pro, Elite and Workstation PCs with select Intel® or AMD processors.

40. Firmware TPM is version 2.0.

53. HP Smart Support is available to commercial customers through your HP Service Representative and HP Factory Configuration Services; or it can be downloaded at: <http://www.hp.com/smart-support>. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights.

Technical Specifications

POWER

Power Supply

HP Smart 65 W USB Type-C® adapter ⁴¹

HP Smart 65 W Slim USB Type-C® adapter ⁴¹

Primary Battery

HP Long Life 4-cell, 54 Wh Li-ion polymer ^{42,43}

HP Long Life 4-cell, 78.5 Wh Li-ion polymer ^{42,43}

Power Cord

Premium 1m C5 power cord

Conventional 1m C5 power cord

Battery life ⁴⁴

Up to 14 hours 45 minutes (54 Wh battery) (MobileMark2018).

Up to 22 hours (78 Wh battery) (MobileMark2018)

41. Availability may vary by country.

42. Battery is internal and not replaceable by customer. Serviceable by warranty.

43. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

44. Windows 10 MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

WEIGHTS & DIMENSIONS

Product Weight

Starting at 2.9 lb (1.31 kg) ⁴⁵

Product Dimensions (w x d x h)

12.57 x 7.98 x 0.65 in

31.93 x 20.26 x 1.66 cm

45. Weight will vary by configuration.

Technical Specifications

PORTS/SLOTS

Ports

- 2 Thunderbolt™ 4 with USB4™ Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4)⁵²
- 2 SuperSpeed USB Type-A 5Gbps signaling rate includes two charging port (USB 3.2 Gen 1)
- 1 HDMI 2.0⁴⁶
- 1 External Nano SIM Slot for WWAN ⁴⁷
- 1 Headphone/Microphone Combo

46. HDMI cable sold separately.

47. SIM slot is not user accessible without WWAN configuration.

52. SuperSpeed USB 20Gbps is not available with Thunderbolt™ 4.

SERVICE AND SUPPORT

1-year or 3-year limited warranty and 90 day software limited warranty options depending on country.

Batteries have a default one year limited warranty except for HP Long Life batteries which will follow the one or three year warranty of the platform. Refer to <http://www.hp.com/support/batterywarranty/> for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: <http://www.hp.com/go/cpc>.⁴⁸

48. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit <http://www.hp.com/go/cpc>. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

CERTIFICATION AND COMPLIANCE

ENERGY STAR® ⁴⁹

EPEAT® 2019 Gold in the U.S. ⁵⁰

Low halogen ⁵¹

TCO 8.0 Certified

49. Configurations of the HP EliteBook x360 1040 G8 Notebook PC that are ENERGY STAR® qualified are identified as HP EliteBook x360 1040 G8 Notebook PC ENERGY STAR on HP websites and on <http://www.energystar.gov>.

50. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit <http://www.epeat.net> for more information.

51. External power supplies, power cords, cables and peripherals are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.

Technical Specifications

SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)	Nominal Operating Voltage	AC 15V
	Average Operating Power	
	Integrated Graphics	Yes
	Discrete Graphics	N/A
Temperature	Max Operating Power	UMA<65W
	Operating	32° to 95° F (0° to 35° C) (not writing optical)
	Non-operating	41° to 95° F (5° to 35° C) (writing optical)
	Relative Humidity	
Relative Humidity	Operating	10% to 90%. (Non-Condensing)
	Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature
Shock	Operating	40 G, 2 ms, half-sine
	Non-operating	200 G, 2 ms, half-sine
Random Vibration	Operating	1.043 grms
	Non-operating	3.5 grms
Altitude (unpressurized)	Operating	-50 to 10,000 ft (-15.24 to 3,048 m)
	Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)
Planned Industry Standard Certifications	UL	Yes
	CSA	Yes
	FCC Compliance	Yes
	ENERGY STAR®	Yes
	EPEAT	Yes
	ICES	Yes
	Australia	Yes
	NZ A-Tick Compliance	Yes
	CCC	Yes
	Japan VCCI Compliance	Yes
	KC	Yes
	BSMI	Yes
	CE Marking Compliance	Yes
	BNCI or BELUS	Yes
	CIT	Yes
	GOST	Yes
	Saudi Arabian Compliance (ICCP)	Yes
	SABS	Yes
	UKRSERTCOMPUTER	Yes

Technical Specifications

DISPLAYS

1. Actual brightness will be lower with touchscreen or Sure View.

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Panel LCD 14 inch FHD (1920.x.1080) Anti-Glare WLED UWVA sRGB 100% cg 400nits eDP 1.4+PSR2 bent LP	Outline Dimensions (W x H x D)	313.67 X 184.17 mm (max)
	Active Area	309.37 X 174.02 mm (typ.)
	Weight	200 g (max)
	Diagonal Size	14.0 inch
	Thickness	2.0 mm/3.8 mm (w/PCB) (max)
	Interface	eDP 1.4
	Surface Treatment	Anti-Glare
	Touch Enabled	Yes
	Contrast Ratio	1200:1 (typ.)
	Refresh Rate	60 Hz
	Brightness	400 nits ¹
	Pixel Resolution	1920 x 1080 (FHD)
	Format	RGB Stripe
	Backlight	LED
	Color Gamut Coverage	sRGB 100% (NTSC 72%)
	Color Depth	8 bits
	Viewing Angle	UWVA 85/85/85/85

Panel LCD 14 inch FHD (1920 x 1080) BrightView WLED UWVA sRGB 100% cg 400nits eDP 1.4+PSR2 bent LP	Outline Dimensions (W x H x D)	313.67 X 184.17 mm (max)
	Active Area	309.37 X 174.02 mm (typ.)
	Weight	200 g (max)
	Diagonal Size	14.0 inch
	Thickness	2.0 mm/3.8 mm (w/PCB) (max)
	Interface	eDP 1.4
	Surface Treatment	BrightView
	Touch Enabled	Yes
	Contrast Ratio	1200:1 (typ.)
	Refresh Rate	60 Hz
	Brightness	400 nits ¹
	Pixel Resolution	1920 x 1080 (FHD)
	Format of LCD Pixel Arrangement	RGB Stripe
	Backlight	LED
	Color Gamut Coverage	sRGB 100% (NTSC 72%)
	Color Depth	8 bits
	Viewing Angle	UWVA 85/85/85/85

Technical Specifications

Panel LCD 14 inch UHD (3840 x 2160) BrightView WLED UWVA HDR-400 sRGB 95% cg 550nits eDP 1.4+PSR2 bent	Outline Dimensions (W x H x D)	313.61 X 184.74 mm (max)
	Active Area	309.31 X 173.98 mm (typ.)
	Weight	200 g (max)
	Diagonal Size	14.0 inch
	Thickness	2.0 mm/3.8 mm (w/PCB) (max)
	Interface	eDP 1.4
	Surface Treatment	BrightView
	Touch Enabled	Yes
	Contrast Ratio	1400:1 (typ.)
	Refresh Rate	60 Hz
	Brightness	550 nits ¹
	Pixel Resolution	3840 x 2160 (UHD)
	Format	RGB Stripe
	Backlight	LED
	Color Gamut Coverage	sRGB 95%
	Color Depth	8 bits+2FRC
	Viewing Angle	UWVA 85/85/85/85

Panel LCD 14-in FHD (1920 x 1080) Anti-Glare WLED UWVA 72% cg 1000nits eDP 1.4+PSR PrivacyG4 NB2Y	Outline Dimensions (W x H x D)	314.612 x 185.33 mm (max.)
	Active Area	309.312 x 173.99 mm
	Weight	230 g (max.)
	Diagonal Size	14.0"
	Thickness	3.9 mm (max.)
	Interface	eDP
	Surface Treatment	Anti-glare
	Touch Enabled	Yes
	Contrast Ratio	1500:1 (typ.)
	Refresh Rate	60 Hz
	Brightness	1000 nits ¹
	Pixel Resolution	1920 x 1080 (FHD)
	Format of LCD Pixel Arrangement	RGB
	Backlight	LED

Technical Specifications

	Color Gamut Coverage	72% of NTSC
	Color Depth	8 bits
	Viewing Angle	UWVA 85/85/85/85
<hr/>		
Panel LCD 14-in FHD (1920 x 1080) BrightView WLED UWVA 72% cg 1000nits eDP 1.4+PSR PrivacyG4 NB2Y	Outline Dimensions (W x H x D)	314.612 x 185.33 mm (max.)
	Active Area	309.312 x 173.99 mm
	Weight	230 g (max.)
	Diagonal Size	14.0"
	Thickness	3.9 mm (max.)
	Interface	eDP
	Surface Treatment	BrightView
	Touch Enabled	Yes
	Contrast Ratio	1500:1 (typ.)
	Refresh Rate	60 Hz
	Brightness	1000 nits ¹
	Pixel Resolution	1920 x 1080 (FHD)
	Format	RGB
	Backlight	LED
	Color Gamut Coverage	72%
	Color Depth	8 bits
	Viewing Angle	UWVA 85/85/85/85

Technical Specifications

STORAGE

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for windows 10 and 11) is reserved for system recovery software.

SSD 128GB 2280 PCIe-3x2 Three Layer Cell	Form Factor	M.2 2280
	Capacity	128 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen3X2
	Maximum Sequential Read	1300 ~ 2047 MB/s
	Maximum Sequential Write	630 ~ 800 MB/s
	Logical Blocks	250,069,680
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security; DIPM; TRIM; DEVSLP

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software

SSD 1TB 2280 PCIe-3x4 NVMe Three Layer Cell single-sided	Form Factor	M.2 2280
	Capacity	1 TB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen3X4
	Maximum Sequential Read	3100 ~ 3500 MB/s
	Maximum Sequential Write	2700 ~ 3200 MB/s
	Logical Blocks	2,000,409,264
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security; TRIM; L1.2

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software

Technical Specifications

SSD 256GB 2280 M2 PCIe-3x4 SS NVMe TLC	Form Factor	M.2 2280
	Capacity	256 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen3X4
	Maximum Sequential Read	2800 ~ 3500 MB/s
	Maximum Sequential Write	1400 ~ 2200 MB/s
	Logical Blocks	500,118,192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security; TRIM; L1.2

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

SSD 256GB 2280 PCIe NVMe Value	Form Factor	M.2 2280
	Capacity	256 GB
	NAND Type	Value
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen3
	Maximum Sequential Read	2100 ~ 2200 MB/s
	Maximum Sequential Write	900 ~ 1400 MB/s
	Logical Blocks	500,118,192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security (optional); TRIM; L1.2

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software

Technical Specifications

**SSD 256GB 2280 PCIe-3x4
NVMe Self Encrypted OPAL2
Three Layer Cell**

Form Factor	M.2 2280
Capacity	256 GB
NAND Type	TLC
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Weight	0.02 lb (10 g)
Interface	PCIe NVMe Gen3X4
Maximum Sequential Read	2800 ~ 3500 MB/s
Maximum Sequential Write	1663 ~ 2200 MB/s
Logical Blocks	500,118,192
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	ATA Security (Option); TCG Opal 2.0; TRIM; L1.2

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software

**SSD 512GB 2280 M2 PCIe-3x4
SS NVMe TLC**

Form Factor	M.2 2280
Capacity	512 GB
NAND Type	TLC
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Weight	0.02 lb (10 g)
Interface	PCIe NVMe Gen3X4
Maximum Sequential Read	3100 ~ 3500 MB/s
Maximum Sequential Write	2400 ~ 2956 MB/s
Logical Blocks	1,000,215,215
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	ATA Security; TRIM; L1.2

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software

**SSD 512GB 2280 PCIe NVMe
Value**

Form Factor	M.2 2280
Capacity	512GB
NAND Type	Value
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Weight	0.02 lb (10 g)
Interface	PCIe NVMe Gen3

Technical Specifications

Maximum Sequential Read	1500 ~ 3500 MB/s
Maximum Sequential Write	1000 ~ 1600 MB/s
Logical Blocks	1,000,215,215
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	ATA Security (optional); TRIM; L1.2

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software

**SSD 512GB 2280 PCIe-3x4
NVMe Self Encrypted OPAL2
Three Layer**

Form Factor	M.2 2280
Capacity	512 GB
NAND Type	QLC+3D XPoint
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Weight	0.02 lb (10 g)
Interface	PCIe NVMe Gen3X2X2
Maximum Sequential Read	Up to 2400 MB/s
Maximum Sequential Write	Up to 1300 MB/s
Logical Blocks	1,000,215,215
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	ATA Security; TRIM; L1.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software

**SSD 2TB 2280 PCIe-3x4 NVMe
Three Layer Cell single-sided**

Form Factor	M.2 2280
Capacity	2 TB
NAND Type	TLC
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Weight	0.02 lb (10 g)
Interface	PCIe NVMe Gen3X4
Maximum Sequential Read	2900 ~ 3500 MB/s
Maximum Sequential Write	2100 ~ 2000 MB/s
Logical Blocks	3,907,029,168
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	ATA Security. TRIM; L1.2

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software

Technical Specifications

SSD 512GB 2280 PCIe-3x4 NVMe Self Encrypted OPAL2 Three Layer	Form Factor	M.2 2280
	Capacity	512 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen3X4
	Maximum Sequential Read	3100 ~ 3500 MB/s
	Maximum Sequential Write	2400 ~ 2956 MB/s
	Logical Blocks	1,000,215,215
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security (Option); TCG Opal 2.0; TRIM; L1.2

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software

Technical Specifications

NETWORKING/COMMUNICATIONS

Intel® Wi-Fi¹ 6 AX201 and Wireless LAN Standards
Bluetooth® 5 (802.11ax
2x2, vPro®, supporting
gigabit file transfer
speeds) vPro®

IEEE 802.11a
IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
IEEE 802.11ax
IEEE 802.11d
IEEE 802.11e
IEEE 802.11h
IEEE 802.11i
IEEE 802.11k
IEEE 802.11r
IEEE 802.11v

Interoperability

Features Wi-Fi 6 technology

Frequency Band

802.11b/g/n/ax
• 2.402 – 2.482 GHz
802.11a/n/ac/ax
• 4.9 – 4.95 GHz (Japan)
• 5.15 – 5.25 GHz
• 5.25 – 5.35 GHz
• 5.47 – 5.725 GHz
• 5.825 – 5.850 GHz

Data Rates

• 802.11b: 1, 2, 5.5, 11 Mbps
• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
• 802.11n: max 300Mbps
• 802.11ac : 1733Mbps
• 802.11ax : max 2.4Gbps

Modulation

Direct Sequence Spread Spectrum
OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security³

• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
• AES-CCMP: 128 bit in hardware
• 802.1x authentication
• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
• WPA2 certification
• WPA3 certification
• IEEE 802.11i
• WAPI

**Network Architecture
Models**

Ad-hoc (Peer to Peer)
Infrastructure (Access Point Required)

Roaming

IEEE 802.11 compliant roaming between access points

Output Power²

• 802.11b : +17dBm minimum
• 802.11g : +16dBm minimum
• 802.11a : +17dBm minimum
• 802.11n HT20(2.4GHz) : +14dBm minimum
• 802.11n HT40(2.4GHz) : +13dBm minimum
• 802.11n HT20(5GHz) : +14dBm minimum

Technical Specifications

	<ul style="list-style-type: none"> • 802.11n HT40(5GHz) : +13dBm minimum • 802.11ac VHT80(5GHz) : +10dBm minimum • 802.11ac VHT160(5GHz) : +10dBm minimum • 802.11ax HE40(2.4GHz) : +12dBm minimum • 802.11ax HE80(5GHz) : +10dBm minimum • 802.11ax HE160(5GHz) : +10dBm minimum
Power Consumption	<ul style="list-style-type: none"> • Transmit mode: 2.0 W • Receive mode: 1.6 W • Idle mode (PSP) 180 mW (WLAN Associated) • Idle mode: 50 mW (WLAN unassociated) • Connected Standby/Modern Standby: 10mW • Radio disabled: 8 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity⁴	<ul style="list-style-type: none"> • 802.11b, 1Mbps : -93.5dBm maximum • 802.11b, 11Mbps : -84dBm maximum • 802.11a/g, 6Mbps : -86dBm maximum • 802.11a/g, 54Mbps : -72dBm maximum • 802.11n, MCS07 : -67dBm maximum • 802.11n, MCS15 : -64dBm maximum • 802.11ac, MCS0(VHT80) : -84dBm maximum • 802.11ac, MCS9(VHT80) : -59dBm maximum • 802.11ac, MCS9(VHT160) : -58.5dBm maximum • 802.11ax, MCS11(HE40) : -57dBm maximum • 802.11ax, MCS11(HE80) : -54dBm maximum • 802.11ax, MCS11(HE160) : -53.5dBm maximum
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCard with CNVi Interface
Dimensions	1. Type 2230: 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm
Weight	1. Type 2230: 2.8g 2. Type 126: 1.3g
Operating Voltage	3.3v +/- 9%
Temperature	Operating: 14° to 158° F (–10° to 70° C) Non-operating: –40° to 176° F (–40° to 80° C)
Humidity	Operating: 10% to 90% (non-condensing) Non-operating: 5% to 95% (non-condensing)
Altitude	Operating: 0 to 10,000 ft (3,048 m) Non-operating: 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED White – Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2/5.0/5.1/5.2 Compliant

Technical Specifications

Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy: 3 Mbps data rate ¹ ; throughput up to 2.17 Mbps BLE: 1 Mbps data rate ¹ ; throughput up to 0.2 Mbps 1. Actual throughput may vary. Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported	Microsoft Windows Bluetooth Software
Link Topology	
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark
Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) BT5.2 ESR9/10 Compliance LE Advertisement Extensions Channel Selection Algo Limited High Duty Cycle Non-Connectable Advertising 2Mbps LE LE Long Range

Technical Specifications

Security & Manageability Intel® vPro™ support with appropriate Intel® chipset components

1. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs.
 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
 3. Check latest software/driver release for updates on supported security features.
 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
 5. Wi-Fi 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.
-

Technical Specifications

Intel® Wi-Fi¹ 6 AX201 and Bluetooth® 5 (802.11ax 2x2, non-vPro®, supporting gigabit file transfer speeds) non-vPro®	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v
	Interoperability	Features Wi-Fi 6 technology
	Frequency Band	802.11b/g/n/ax • 2.402 – 2.482 GHz 802.11a/n/ac/ax • 4.9 – 4.95 GHz (Japan) • 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.47 – 5.725 GHz • 5.825 – 5.850 GHz
	Data Rates	• 802.11b: 1, 2, 5.5, 11 Mbps • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11n: max 300Mbps • 802.11ac : 1733Mbps • 802.11ax : max 2.4Gbps
	Modulation	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
	Security³	• IEEE compliant 64 /128 bit WEP encryption for a/b/g mode only • AES-CCMP: 128 bit in hardware • 802.1x authentication • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. • WPA2 certification • WPA3 certification • IEEE 802.11i • WAPI
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power²	• 802.11b : +17dBm minimum • 802.11g : +16dBm minimum • 802.11a : +17dBm minimum • 802.11n HT20(2.4GHz) : +14dBm minimum • 802.11n HT40(2.4GHz) : +13dBm minimum • 802.11n HT20(5GHz) : +14dBm minimum

Technical Specifications

	<ul style="list-style-type: none"> • 802.11n HT40(5GHz) : +13dBm minimum • 802.11ac VHT80(5GHz) : +10dBm minimum • 802.11ac VHT160(5GHz) : +10dBm minimum • 802.11ax HE40(2.4GHz) : +12dBm minimum • 802.11ax HE80(5GHz) : +10dBm minimum • 802.11ax HE160(5GHz) : +10dBm minimum
Power Consumption	<ul style="list-style-type: none"> • Transmit mode 2.0 W • Receive mode 1.6 W • Idle mode (PSP) 180 mW (WLAN Associated) • Idle mode 50 mW (WLAN unassociated) • Connected Standby 10mW • Radio disabled 8 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity⁴	<ul style="list-style-type: none"> • 802.11b, 1Mbps : -93.5dBm maximum • 802.11b, 11Mbps : -84dBm maximum • 802.11a/g, 6Mbps : -86dBm maximum • 802.11a/g, 54Mbps : -72dBm maximum • 802.11n, MCS07 : -67dBm maximum • 802.11n, MCS15 : -64dBm maximum • 802.11ac, MCS0(VHT80) : -84dBm maximum • 802.11ac, MCS9(VHT80) : -59dBm maximum • 802.11ac, MCS9(VHT160) : -58.5dBm maximum • 802.11ax, MCS11(HE40): -57dBm maximum • 802.11ax, MCS11(HE80): -54dBm maximum • 802.11ax, MCS11(HE160): -53.5dBm maximum
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Temperature	Operating: 14° to 158° F (–10° to 70° C) Non-operating: –40° to 176° F (–40° to 80° C)
Humidity	Operating: 10% to 90% (non-condensing) Non-operating: 5% to 95% (non-condensing)
Altitude	Operating: 0 to 10,000 ft (3,048 m) Non-operating: 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED Off – Radio ON
HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2 Wireless Technology	
Bluetooth Specification	4.0/4.1/4.2/5.0/5.1/5.2 Compliant
Frequency Band	2402 to 2480 MHz

Technical Specifications

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Transmit Power	Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5) The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported	Microsoft Windows Bluetooth Software
Link Topology	
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark
Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) BT5.2 ESR9/10 Compliance LE Advertisement Extensions Channel Selection Algo Limited High Duty Cycle Non-Connectable Advertising 2Mbps LE LE Long Range

Technical Specifications

1. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs.
2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
3. Check latest software/driver release for updates on supported security features.
4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
5. Wi-Fi 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

Intel® XMM™ 7360 LTE-Advanced CAT9¹	Technology/Operating bands	FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 1400 (Band 11), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1400 (Band 21), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 1700/2100 (Band 66). TDD LTE: 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41). HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz
	Wireless protocol standards	3GPP Release 11 LTE Specification CAT.9, MAX 60MHz aggregation BW WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
	GPS	Standalone, A-GPS (MS-A, MS-B)
	GPS bands	GPS 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 ± 2.046 MHz
	Maximum data rates	LTE: 450 Mbps (DL 3CA), 50 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
	Maximum output power	LTE: 23 dBm HSPA+: 23.5 dBm
	Maximum power consumption	LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)
	Form Factor	M.2, 3042-S3 Key B
	Weight	6.2 g
	Dimensions (Length x Width x Thickness)	42 x 30 x 2.3 mm

1. Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

Technical Specifications

NXP NPC300 Near Field Communication Module

Dimensions (L x W x H)	Module 17 mm by 10 mm by 2.0 mm
Chipset	NPC300
System interface	I2C
NFC RF standards	ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092 ECMA-340 NFCIP-1 Target and Initiator ECMA-320 NFCIP-2
NFC Forum Support	Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2
Reader (PCD-VCD) Mode(1)	ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire FeliCa Jewel and Topaz cards
Card Emulation (PICC-VICC) Mode(1)	ISO/IEC 14443 A ISO/IEC 14443 B and B' MIFARE FeliCa
Frequency	13.56 MHz
NFC Modes Supported	Reader/Writer, Peer-to-Peer
Raw RF Data Rates	106, 212, 424, 848 kbps
Operating temperature	0°C to 70°C
Storage temperature	-20°C to 125°C
Humidity	10-90% operating 5-95% non-operating
Supply Operating voltage	2.97 to 5.5 Volts
I/O Voltage	1.8V or 3.3V

Power Consumption (Booster enable, VBAT= 3.3V, VCC_BOOST = 5V)

Mode	Power Consumption, Typical (2)
Polling	7.3 mA
Detected Test Tag Type 1	32.9 mA
Detected Test Tag Type 2	70.7 mA
Detected Test Tag Type 3	79.2 mA
Detected Test Tag Type 4	64.9 mA
Antenna	Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna matching is external to module.

Technical Specifications

1. With application or UICC support
 2. Actual Power Consumption is dependent on NFC antenna and matching circuit and on the particular polling sequence and period configured.
-

Technical Specifications

POWER

AC Adapter 65 Watt nPFC Slim USB type C Straight 1.0 m	Dimensions	88 x 53.5 x 21mm
	Weight	unit: 220g +/- 10g
	Input	100 to 240 VAC
	Input Efficiency	81.5% min at 115 Vac/ 230Vac @ 5V/3A 86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A
	Input frequency range	47 ~ 63 Hz
	Input AC current	1.7 A at 90 VAC and maximum load
	Output power	65W
	DC output	5V/9V/12V/15V/20V
	Hold-up time	5ms at 115 Vac input
	Output current limit	< 8.0A
Connector	Output	USB Type C
	Environmental Design	Operating temperature 32oFto 95oF (0oto 35oC) Non-operating (storage) temperature -4oFto 185oF (-20oto 85oC) Altitude 0 to 16,400 ft (0 to 5000m) Humidity 5% to 95% Storage Humidity 5% to 95%
	EMI and Safety Certifications	Eg: - CE Mark - full compliance with LVD and EMC directives - Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1 , Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, NOM-001 NYCE. - MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 65 Watt nPFC Standard USB type C Straight 1.0 m	Dimensions	90.0 x 51 x 28.5mm
	Weight	unit: 250g +/- 10g
	Input	100 to 240 VAC
	Input Efficiency	81.5% min at 115 Vac/ 230Vac @ 5V/3A 86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A
	Input frequency range	47 ~ 63 Hz
	Input AC current	1.6 A at 90 VAC and maximum load
	Output power	65W
	DC output	5V/9V/12V/15V/20V
	Hold-up time	5ms at 115 Vac input
	Output current limit	8.0A Max.
Connector	Output	USB TYPE C
	Environmental Design	Operating temperature 32°F to 95°F (0°to 35°C) Non-operating (storage) temperature -4°F to 185°F (-20°to 85°C)

Technical Specifications

EMI and Safety Certifications

Altitude	0 to 16,400 ft (0 to 5000m)
Humidity	20% to 95%
Storage Humidity	10% to 95%
Eg:	
	- CE Mark - full compliance with LVD and EMC directives
	- Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1, SELV;
	Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, NOM-001 NYCE.
	- MTBF - over 200,000 hours at 25°C ambient condition

Battery HK 4 Cell WH 54 Long Life -PL

Dimensions (H x W x L)	5.85mm*89.7mm*268.2mm
Weight	221g±10g
Cells/Type	4-cell; Polymer
Energy	Voltage 7.7V
	Amp-hour capacity 7.013Ah
	Watt-hour capacity 54Wh
	Operating (Charging) 0~45°C
Temperature	Operating (Discharging) -10°C~60°C
	Fuel Gauge LED No
Optional Travel Battery Available	N/a

Battery HK 4 Cell WH 78 Long Life -PL

Dimensions (H x W x L)	6.49mm*94.6mm*281.6mm
Weight	295g±10g
Cells/Type	4-cell; Polymer
Energy	Voltage 7.72V
	Amp-hour capacity 10.18Ah
	Watt-hour capacity 78.5Wh
	Operating (Charging) 0~45°C
Temperature	Operating (Discharging) -10°C~60°C
	Fuel Gauge LED No
Optional Travel Battery Available	N/A

Technical Specifications

FINGERPRINT READER

Model:
Synaptics Validity VFS7604 touch sensor
Mobile Voltage Operation:
3.0V to 3.6V
Operating Temperature:
0~60°C
Current Consumption Image:
100mA Max
Low Latency Wait For Finger:
260 uA
Capture Rate:
<30msec per image
ESD Resistance:
IEC 61000-4-2 4B (+/-15KV)
Detection Matrix:
363 dpi / 7.4x6mm sensor area
FRR (False Reject Rate) / FAR (False Acceptance Rate):
FRR <1% @ 1:50K FAR

Technical Specifications

ENVIRONMENTAL DATA

Eco-Label Certifications & declarations	<p>This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:</p> <ul style="list-style-type: none"> • IT ECO declaration • US ENERGY STAR® • US Federal Energy Management Program (FEMP) • EPEAT[®] Gold registered in the United States. See http://www.epeat.net for registration status in your country. • TCO 8.0 • China Energy Conservation Program (CECP) • China State Environmental Protection Administration (SEPA) • Taiwan Green Mark • Korea Eco-label • Japan PC Green label* 		
Sustainable Impact Specifications	<ul style="list-style-type: none"> • Ocean-bound plastic in Speaker Enclosure • 23.88% post-consumer recycled plastic • External Power Supply 90% Efficiency • Low halogen • Outside Box and corrugated cushions are 100% sustainably sourced and recyclable • Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable • Bulk packaging available 		
System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a “Typically Configured Notebook”.		
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Sort idle)	6.90 W	7.08 W	6.97 W
Normal Operation (Long idle)	0.77 W	0.83 W	0.76 W
Sleep	0.77 W	0.83 W	0.76 W
Off	0.35 W	0.31 W	0.29 W
	<p>Note: Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.</p>		
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	22 BTU/hr	22 BTU/hr	22 BTU/hr
Normal Operation (Long idle)	3 BTU/hr	3 BTU/hr	2 BTU/hr
Sleep	3 BTU/hr	3 BTU/hr	2 BTU/hr
Off	1 BTU/hr	1 BTU/hr	1 BTU/hr

Technical Specifications

	*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.		
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L _{WAd} , bels)	Sound Pressure (L _{pAm} , decibels)	
Typically Configured – Idle	2.6	14.4	
Fixed Disk – Random writes	2.8	15.7	
Optical Drive – Sequential reads	3.9	29.3	
Longevity and Upgrading	This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the Spare parts are available throughout the warranty period and or for up to “5” years after the end of production.		
Additional Information	<ul style="list-style-type: none">• This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.• This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.• This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).• This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net• Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.• This product is 23.88% recycle-able when properly disposed of at end of life.		
Packaging Materials	External:	PAPER/Corrugated	222 g
	Internal:	PLASTIC/polypropylene	3 g
		PLASTIC/Polyethylene low density	8 g
		PAPER/paperboard	51 g
		PAPER/Molded pulp	164 g
	The plastic packaging material contains at least 0% recycled content.		
	The corrugated paper packaging materials contains at least 60% recycled content.		
RoHS Compliance	<p>HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam.</p> <p>We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.</p> <p>We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve. To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.</p>		
Material Usage	This product does not contain any of the following substances in excess of regulatory limits (refer to		

Technical Specifications

	<p>the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):</p> <ul style="list-style-type: none"> • Asbestos • Certain Azo Colorants • Certain Brominated Flame Retardants – may not be used as flame retardants in plastics • Cadmium • Chlorinated Hydrocarbons • Chlorinated Paraffins • Bis(2-Ethylhexyl) phthalate (DEHP) • Benzyl butyl phthalate (BBP) • Dibutyl phthalate (DBP) • Diisobutyl phthalate (DIBP) • Formaldehyde • Halogenated Diphenyl Methanes • Lead carbonates and sulfates • Lead and Lead compounds • Mercuric Oxide Batteries • Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. • Ozone Depleting Substances • Polybrominated Biphenyls (PBBs) • Polybrominated Biphenyl Ethers (PBBEs) • Polybrominated Biphenyl Oxides (PBBOs) • Polychlorinated Biphenyl (PCB) • Polychlorinated Terphenyls (PCT) • Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications. • Radioactive Substances • Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
Packaging Usage	<p>HP follows these guidelines to decrease the environmental impact of product packaging:</p> <ul style="list-style-type: none"> • Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. • Eliminate the use of ozone-depleting substances (ODS) in packaging materials. • Design packaging materials for ease of disassembly. • Maximize the use of post-consumer recycled content materials in packaging materials. • Use readily recyclable packaging materials such as paper and corrugated materials. • Reduce size and weight of packages to improve transportation fuel efficiency. • Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management and Recycling	<p>HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.</p> <p>The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.</p>

Technical Specifications

HP, Inc. Corporate Environmental Information	<p>For more information about HP's commitment to the environment:</p> <p>Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html</p> <p>Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html</p> <p>ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf</p>
footnotes	<ul style="list-style-type: none"> • Percentage of ocean-bound plastic contained in each component varies by product • Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard. • External power supplies, WWAN modules, power cords, cables and peripherals excluded. • 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers. • Fiber cushions made from 100% recycled wood fiber and organic materials.

COUNTRY OF ORIGIN

China

Options and Accessories (sold separately and availability may vary by country)

Type	Description	Part #
Cases	HP Business Slim 14.1 Top Load	2SC65AA, 2SC65UT, 2SC65ET
	HP Executive 15.6 Backpack	6KD07AA, 6KD07UT, 6KD07ET
	HP Executive Slim 14.1 Top Load	6KD04AA, 6KD04UT, 6KD04ET
Docking	HP Thunderbolt 120W Dock G2	6HP48AA, 2UK37AA, 2UK37ET
	HP Thunderbolt 120W Dock w/Audio G2	3YE87AA, 2UK37UT, 3YE87ET
	HP Thunderbolt 230W Dock w/Combo Cable G2	3TR87AA, 3TR87UT, 3TR87ET
	HP USB-C 120W G5 Dock	26D32AA, 5TW10AA, 5TW10UT, 5TW10ET
	HP USB-C Mini Dock	2SR85AA, 1PM64AA, 1PM64UT, 1PM64ET
	HP USB-C/A 120W Universal Dock G2	5TW13AA, 5TW13UT, 5TW13ET
Input/Output	HP HDMI to VGA Adapter	H4F02AA, H4F02UT, H4F02ET
	HP TB Dock 120W G2 Cable	3XB94AA, 3XB94UT, 3XB94ET
	HP TB Dock 230W G2 Combo Cable	3XB96AA, 3XB96UT, 3XB96ET
	HP USB-C to DisplayPort Adapter	N9K78AA, N9K78UT
	HP USB-C to HDMI 2.0 Adapter	2PC54AA, 1WC36UT, 1WC36AA
	HP USB-C to RJ45 Adapter	V8Y76AA, V7W66AA, V7W66UT
	HP USB to Gig RJ45 Adapter	N7P47AA
	HP USB-C to USB-A Hub	Z8W90AA, Z6A00AA, Z6A00UT, Z6A00ET
	HP USB Collaboration Keyboard	Z9N38AA, Z9N38UT
	HP Wireless USB Premium Keyboard	Z9N41AA, Z9N41AT
	HP WL BT Collaboration Keyboard	Z9N39AA, Z9N39UT
	HP WL USB Keyboard	T6U20AA, T6U20UT
	HP Slim Wireless Keyboard and Mouse	T6L04AA, T6L04UT
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA, 9SR36UT, 9SR36ET
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
	HP 235 WL Mouse and Keyboard Combo	1Y4D0AA
	HP 125 Wired Keyboard	266C9AA
	HP 320M Wired Mouse	9VA80AA, 9VA80UT, 9VA80ET
	HP Comfort Grip Wireless USB Mouse	H2L63AA, H2L63UT
	HP Presenter Bluetooth Mouse	2CE30AA, 2CE30UT, 2CE30ET
	HP Travel Bluetooth Mouse	6SP30AA, 6SP30UT, 6SP30ET
	HP Travel USB Mouse	G1K28AA, G1K28ET
	HP UltraMobile Wireless Mouse	H6F25AA, H6F25UT
	HP Active RECHBL Pen G3	6SG43AA, 6SG43UT
	HP 65W USB-C AC Power Adapter	1HE08AA, 1HE08UT
	HP 65W USB-C LC AC Power Adapter	1P3K6AA, 1P3K6UT
	HP 65W USB-C Slim Travel AC Power Adapter	X7W50AA, 3PN48AA, 3PN48UT

Options and Accessories (sold separately and availability may vary by country)

Power	HP USB Power Bank	N9F71AA, N9F71UT
	HP USB-C Essential Power Bank	3TB55AA, 3TB55UT
	HP USB DVD-Writer EXT ODD	Y3T76AA, F2B56AA, F2B56UT, F2B56ET
Storage	HP Dual Head Nano Cable Lock	1AJ41AA, 1AJ41UT
Security	HP Nano Cable Lock	1AJ39AA, 1AJ39UT
	HP SureKey Standard/Nano/Wedge Cable Lock	6UW42AA, 6UW42UT
UCC	HP BT UC WL Duo Headset	W3K09AA#ABB, W3K09AA#UUF
	HP Wired Thunderbolt Audio Module	3AQ21AA, 3AQ21UT, 3AQ21ET
	HP Wired USB-A Stereo Headset	T1A67AA
	HP Wireless BT UC WL Mono Headset	W3K08AA#ABB, W3K08AA#UU

Summary of Changes

Date of change:	Version History:		Description of change:
January 27, 2021	V1 to V2	Update	USB ports to new industry standards, WPA3 certification
February 10, 2021	V2 to V3	Add	Environmental Data
February 17, 2021	V3 to V4	Update	Environmental Data
March 2, 2021	V4 to V5	Update	Battery Life
March 15, 2021	V5 to V6	Update	Battery Life
April 19, 2021	V6 to V7	Update	Input/ Output Section Updated
May 6, 2021	V7 to V8	Remove	Processors base frequency/Added HP Smart Support
May 27, 2021	V8 to V9	Update	HP Pro Security Edition to HP Wolf Pro Security Edition
June 11, 2021	V9 to V10	Remove	HP WorkWell from Software and Security section
September 7, 2021	V10 to V11	Update	Techspecs in Networking and Power section
October 14, 2021	V11 to V12	Update	Environmental Data
November 9, 2021	V12 to V13	Update	Auto Lock and Awake in At a Glance section
November 11, 2021	V13 to V14	Update	Windows 10 with Free upgrade to Windows 11 when available in OS section and footnote.
December 13, 2021	V14 to V15	Update	OS footnotes and Wi-Fi 6 footnotes
February 28, 2022	V15 to V16	Added	Processors base frequency
April 20, 2022	V16 to V17	Added	Reference for USB ports
September 7, 2022	V17 to V18	Removed	Tile App

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